TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (MACHII π -MOSVI)

2SK3911

Switching Regulator Applications

Unit: mm

• Small gate charge: Qg = 60 nC (typ.)

• Low drain-source ON resistance: $RDS(ON) = 0.22\Omega$ (typ.)

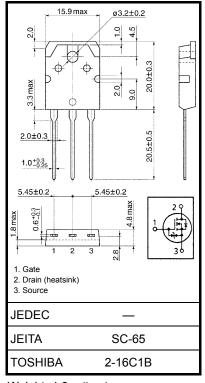
• High forward transfer admittance: $|Y_{fs}| = 11 \text{ S (typ.)}$

• Low leakage current: $IDSS = 500 \mu A (VDS = 600 V)$

• Enhancement model: $V_{th} = 2.0 \sim 4.0 \text{ V (V}_{DS} = 10 \text{ V}, I_D = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	600	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	600	V	
Gate-source voltage		V_{GSS}	±30	V	
Drain current	DC (Note 1)	ΙD	20	Α	
	Pulse (Note 1)	I _{DP}	80		
Drain power dissipati	on (Tc = 25°C)	P _D	150	W	
Single pulse avalanche energy (Note 2)		E _{AS}	792	mJ	
Avalanche current		I _{AR}	20	Α	
Repetitive avalanche energy (Note 3)		E _{AR}	15	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	



Weight: 4.6 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	0.833	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	50	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C during use of the device.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 3.46 mH, $I_{AR} = 20 \text{ A}$, $R_G = 25 \Omega$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

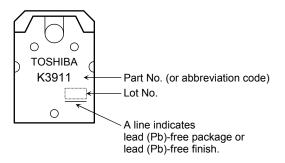
Electrical Characteristics (Ta = 25°C)

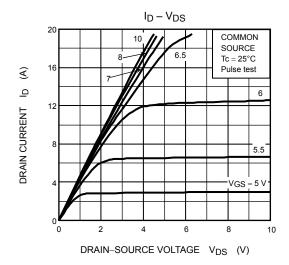
Chai	racteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rent	I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Gate-source brea	akdown voltage	V (BR) GSS	$I_D = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	٧
Drain cutoff curre	ent	I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V	_	_	500	μА
Drain-source bre	akdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	600	_	_	٧
Gate threshold ve	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	٧
Drain-source ON	resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 10 A	_	0.22	0.32	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 10 A	3.0	11	_	S
Input capacitance		C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	4250	_	pF
Reverse transfer capacitance		C _{rss}		_	10	_	
Output capacitance		Coss		_	420	_	
Switching time	Rise time	t _r	$\begin{array}{c c} 10 \text{ V} & \text{I}_D = 10 \text{ A} & \text{V}_{OUT} \\ \hline \text{VGS} & \text{V} & \text{RL} = \\ 4.7 \Omega & \text{RL} = \\ \hline \text{VDD} \approx 200 \text{ V} \end{array}$	_	12		
	Turn-on time	t _{on}		_	45	_	
	Fall time	t _f		_	12	_	ns
	Turn-off time	t _{off}	Duty \leq 1%, $t_W = 10 \mu s$	_	80	_	
Total gate charge		Qg		_	60	_	
Gate-source charge		Q _{gs}	$V_{DD} \simeq 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	_	50	_	nC
Gate-drain charge		Q _{gd}		_	10		

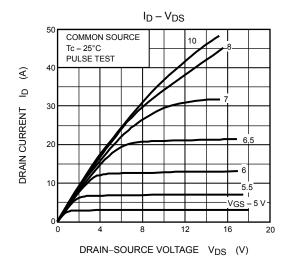
Source-Drain Ratings and Characteristics (Ta = 25°C)

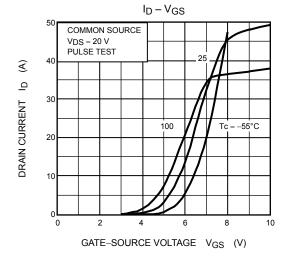
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	20	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	80	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 20 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 20 A, V _{GS} = 0 V,	_	1350	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 100 A/μs	_	24	_	μС

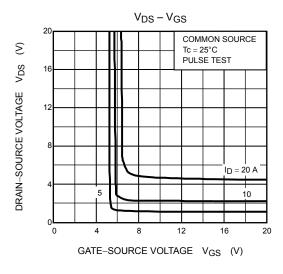
Marking

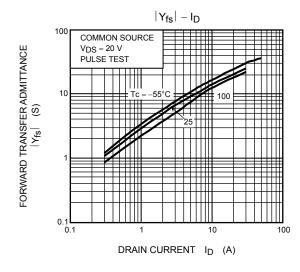


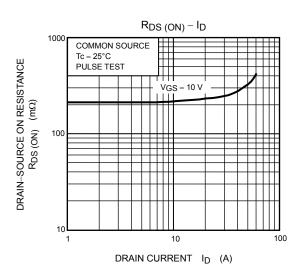


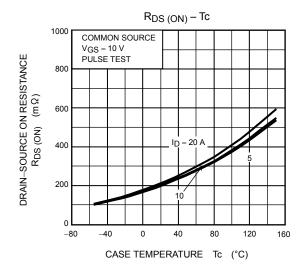


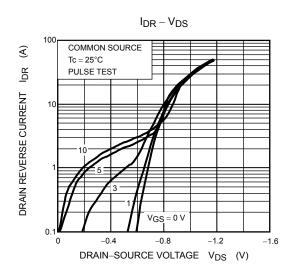


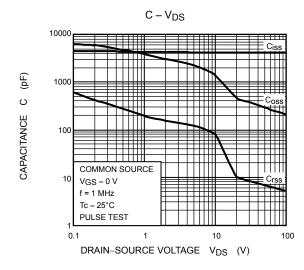


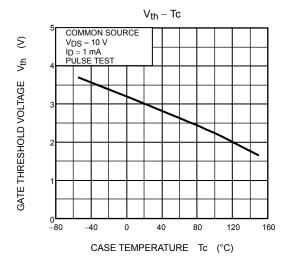


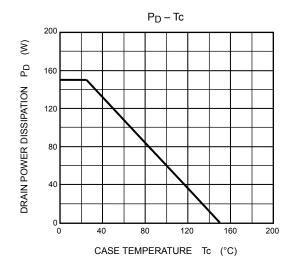


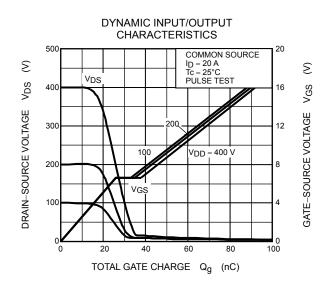


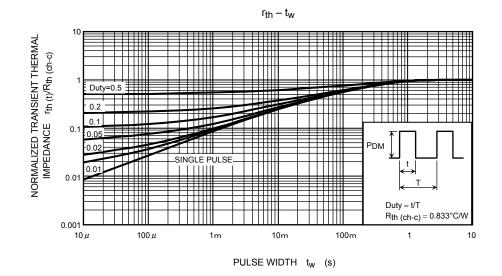


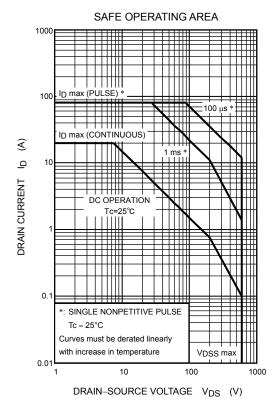


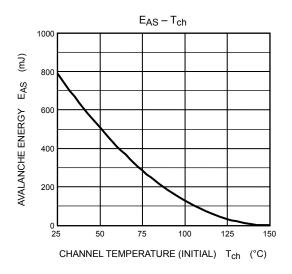


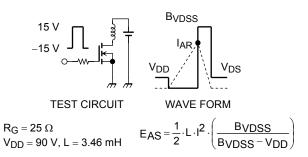












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